

PATENT ASSIGNMENT

Electronic Version v1.1

Stylesheet Version v1.1

SUBMISSION TYPE:	CORRECTIVE ASSIGNMENT												
NATURE OF CONVEYANCE:	Corrective Assignment to correct the 12252858 previously recorded on Reel 022098 Frame 0884. Assignor(s) hereby confirms the ASSIGNMENT OF ASSIGNOR'S INTEREST.												
CONVEYING PARTY DATA													
<table border="1"><thead><tr><th>Name</th><th>Execution Date</th></tr></thead><tbody><tr><td>Mingda Shao</td><td>01/12/2009</td></tr><tr><td>Guoqing Yu</td><td>01/12/2009</td></tr><tr><td>Wei Wang</td><td>01/12/2009</td></tr><tr><td>Hanyu Li</td><td>01/12/2009</td></tr><tr><td>Xiaohua Huang</td><td>01/12/2009</td></tr></tbody></table>		Name	Execution Date	Mingda Shao	01/12/2009	Guoqing Yu	01/12/2009	Wei Wang	01/12/2009	Hanyu Li	01/12/2009	Xiaohua Huang	01/12/2009
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CORRESPONDENCE DATA													
Fax Number: (617)646-8646 <i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>													
Phone: 617-646-8000													
Email: atrendell@wolfgreenfield.com													
Correspondent Name: Wolf, Greenfield & Sacks, P.C.													
Address Line 1: 600 Atlantic Avenue													
Address Line 4: Boston, MASSACHUSETTS 02210													
ATTORNEY DOCKET NUMBER:	U1167.70010US00												

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PATENT  
REEL: 022186 FRAME: 0543

NAME OF SUBMITTER:

Jame

Total Attachments: 4

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**PATENT**

**REEL: 022186 FRAME: 0544**

PATENT ASSIGNMENT

Electronic Version v1.1  
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01/13/2009  
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SUBMISSION TYPE:	NEW ASSIGNMENT												
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Address Line 1: 600 Atlantic Avenue													
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NAME OF SUBMITTER:	James H. Morris												

OP \$40.00 12252858

**Total Attachments: 2**

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**PATENT**

**REEL: 022186 FRAME: 0546**

**ASSIGNMENT**

For good and valuable consideration, the receipt of which is hereby acknowledged, the undersigned hereby:

Sell, assign and transfer to China Wafer Level CSP Ltd., a corporation having a place of business at 11B/C, Suchun Industrial Square, 428 Xinglong Street, Suzhou Industrial Park, Jiang Su Province 215126, P.R. China, its successors, assigns and legal representatives, all hereinafter referred to as the Assignee, the entire right, title and interest for the United States and all foreign countries, in and to any and all inventions which are disclosed in the application for United States Letters Patent filed on        as serial        and entitled WLCSP TARGET AND METHOD FOR FORMING THE SAME, and in and to said application and all divisional, continuing, substitute, renewal, reissue and all other applications for Letters Patent which have been or shall be filed in the United States and all foreign countries on any of said inventions; and in and to all original and reissued patents which have been or shall be issued in the United States and all foreign countries on said inventions including the right to apply for patent rights in each foreign country and all rights to priority;

Agree that said Assignee may apply for and receive Letters Patent and utility model and industrial design registrations for said inventions in its own name; and when requested, without charge to but at the expense of said Assignee, I agree to carry out in good faith the intent and purpose of this assignment, by executing all non-provisional, divisional, continuing, substitute, renewal, reissue, and all other patent, utility model and industrial design applications on any and all said inventions, by executing all rightful oaths, assignments, powers of attorney and other papers, by communicating to said Assignee all facts known to me relating to said inventions and the history thereof, and generally by doing everything reasonably possible which said Assignee shall consider desirable for aiding in securing and maintaining proper protection for said inventions and for vesting title to said inventions and all applications for patents and all patents on said inventions, in said Assignee;

Request the Honorable Director of the United States Patent and Trademark Office to issue said Letters Patent to said Assignee;

Authorize and request Wolf, Greenfield & Sacks, P.C. to supply any missing patent/application identification information or correct any errors in the patent/application identification information provided above, whether discovered prior to or after recordation;

Covenant with said Assignee that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by me and that full right to convey the same as herein expressed is possessed by me; and

Appoint Assignee, through its designee, my attorney-in-fact to execute, in my name and on my behalf, any and all documents required to effectuate this Assignment, specifically including, but not limited to, those documents specified above and any necessary corrective assignments.

Dated: 2009.01.12 Signature Mingda Shao  
Printed Name: Mingda SHAO

Dated: 2009.01.12 Signature Guoqing Yu  
Printed Name: Guoqing YU

Dated: 2009.01.12 Signature Wei Wang  
Printed Name: Wei WANG

Dated: 2009.01.12 Signature Hanyu Li  
Printed Name: Hanyu LI

Dated: 2009.01.12 Signature Xiaohua Huang  
Printed Name: Xiaohua HUANG